

Low-Voltage, 0.8 Ω R_{ON} , Dual SPST Analog Switch

DESCRIPTION

The DG2741, DG2742, DG2743 are low voltage, single supply, dual SPST analog switches. Designed for high performance switching of analog signals, the DG2741, DG2742, DG2743 provide low on-resistance (0.8 Ω at + 2.7 V), fast speed (t_{ON} , t_{OFF} at 35 ns and 33 ns) and the ability to handle signals over the entire analog voltage range.

When operated on a + 3 V supply, control pins are compatible with 1.8 V digital logic. Additionally, on-resistance flatness and matching (0.18 Ω and 0.08 Ω , respectively) offer high accuracy between channels.

The DG2741 contains two normally open (NO) switches, the DG2742 contains two normally closed (NC) switches, and the DG2743 contains one normally open and one normally closed switch. Break-before-make is guaranteed.

Built on Vishay Siliconix's low voltage submicron CMOS process, the DG2741, DG2742, DG2743 were designed to offer solutions that extend beyond audio/video functions, to providing the performance required for today's demanding mixed-signal switching in portable applications.

FEATURES

- Low voltage operation (1.6 V to 3.6 V)
- Low on-resistance - $R_{DS(on)}$: 0.8 Ω at 2.7 V
- High current handling capacity: 150 mA continuous
- Off-isolation: - 56 dB at 1 MHz
- Fast switching: 25 ns t_{ON}
- Low charge injection - Q_{INJ} : 5.8 pC
- Low power consumption: < 1 μ W
- ESD protection > 2 000 V

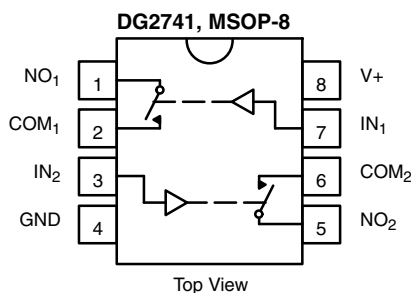
BENEFITS

- High accuracy
- High bandwidth
- TTL and low voltage logic compatibility
- Low power consumption
- Reduced PCB space (SOT23-8 and MSOP-8)

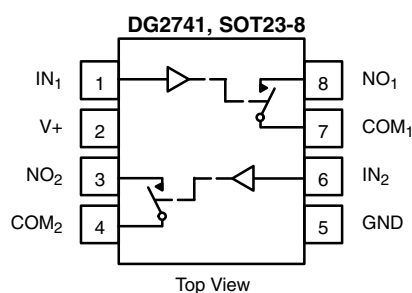
APPLICATIONS

- Mixed signal routing
- Portable and battery operated systems
- Low voltage data acquisition
- Modems
- PCMCIA cards

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION (DG2741)



Device Marking: 2741

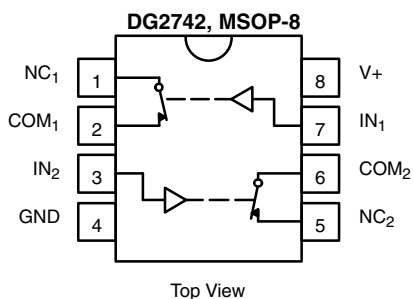


Device Marking: F3

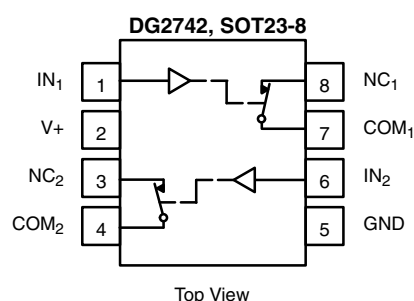
TRUTH TABLE (DG2741)

Logic	Switch
0	Off
1	On

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION (DG2742, DG2743)

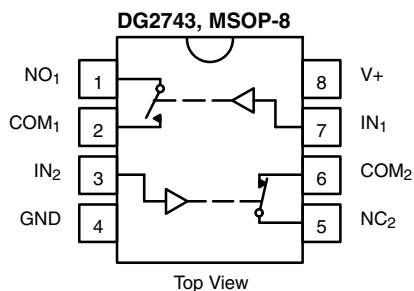


Device Marking: 2742

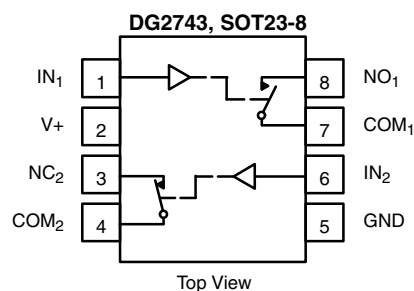


Device Marking: F4

TRUTH TABLE (DG2742)	
Logic	Switch
0	On
1	Off



Device Marking: 2743



Device Marking: F5

TRUTH TABLE (DG2743)		
Logic	Switch-1	Switch-2
0	Off	On
1	On	Off

ORDERING INFORMATION		
Temp. Range	Package	Part Number
- 40 °C to 85 °C	MSOP-8	DG2741DQ-T1
		DG2742DQ-T1
		DG2743DQ-T1
	SOT23-8	DG2741DS-T1
		DG2742DS-T1
		DG2743DS-T1

**ABSOLUTE MAXIMUM RATINGS** ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Parameter	Limit	Unit
Referenced V_+ to GND	- 0.3 to + 4 V	V
IN, COM, NC, NO ^a	- 0.3 V to ($V_+ + 0.3\text{ V}$)	
Continuous Current (NO, NC and COM Pins)	± 200	mA
Peak Current (Pulsed at 1 ms, 10 % duty cycle)	± 300	
ESD per Method 3015.7	> 2	kV
Storage Temperature (D Suffix)	- 65 to 150	$^{\circ}\text{C}$
Power Dissipation (Packages) ^c	6-Pin SC-70 ^c	mW

Notes:

a. Signals on NC, NO, or COM or IN exceeding V_+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

b. All leads welded or soldered to PC board.

c. Derate 3.1 mW/ $^{\circ}\text{C}$ above 70 $^{\circ}\text{C}$.**SPECIFICATIONS** ($V_+ = 1.8\text{ V}$)

Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 1.8 V, ± 10 %, VIN = 0.4 or 1.0 V ^e	Temp. ^a	Limits - 40 °C to 85 °C			Unit
				Min. ^b	Typ. ^c	Max. ^b	
Analog Switch							
Analog Signal Range ^d	VNO, VNC VCOM		Full	0		V+	V
On-Resistance	RON	V+ = 1.8 V, VCOM = 0.9 V INO, INC = 10 mA	Room Full ^d		0.9	2.5 4.0	Ω
RON Flatness ^d	RON Flatness	V+ = 1.8 V, VCOM = 0 to V+, INO, INC = 10 mA	Room		0.25		
RON Match ^d	ΔRON		Room		0.05		
Switch Off Leakage Current ^f	INO(off) INC(off)	V+ = 1.8 V VNO, VNC = 0.2 V/2.0 V, VCOM = 1.5 V/0.3 V	Room Full ^d	- 1 - 10		1 10	nA
	ICOM(off)		Room Full ^d	- 1 - 10		1 10	
Channel-On Leakage Current ^f	ICOM(on)	V+ = 1.8 V, VNO, VNC = VCOM = 0.3 V/1.5 V	Room Full ^d	- 1 - 10		1 10	
Digital Control							
Input High Voltage	VINH		Full	1.0			V
Input Low Voltage	VINL		Full			0.4	
Input Capacitance ^d	Cin		Full		5.5		pF
Input Current ^f	IINL or IINH	VIN = 0 or V+	Full	- 1		1	μA
Dynamic Characteristics							
Turn-On Time ^d	tON	VNO or VNC = 1.5 V, RL = 50 Ω, CL = 35 pF figures 1 and 2	Room Full ^d		33	45 50	ns
Turn-Off Time ^d	tOFF		Room Full ^d		27	40 45	
Break-Before-Make Time ^d	td		Room	3			
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω, figure 3	Room		20		pC
Off-Isolation ^d	OIRR	RL = 1 kΩ, CL = 5 pF, f = 1 MHz	Room		55		dB
Crosstalk ^d	XTALK		Room		91		
NO, NC Off Capacitance ^d	CNO(off) CNC(off)	VIN = 0 or V+, f = 1 MHz	Room		88		pF
Channel-On Capacitance ^d	CON		Room		105		

SPECIFICATIONS (V+ = 3.0 V)							
Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 3 V, ± 10 %, VIN = 0.5 or 1.4 V ^e	Temp. ^a	Limits - 40 °C to 85 °C			Unit
				Min. ^b	Typ. ^c	Max. ^b	
Analog Switch							
Analog Signal Range ^d	VNO, VNC VCOM		Full	0		V+	V
On-Resistance	RON	V+ = 2.7 V, VCOM = 0.2 V/1.5 V, INO INC = 100 mA	Room Full		0.4	0.8 0.9	Ω
RON Flatness	RON Flatness	V+ = 2.7 V, VCOM = 1.5, 2 V, INO, INC = 100 mA	Room		0.8	0.18	
RON MatchFlat	ΔRON		Room		0.05	0.08	
Switch Off Leakage Current	INO(off) INC(off)	V+ = 3.3 V VNO, VNC = 0.3 V/3 V, VCOM = 3 V/0.3 V	Room Full	- 1 - 10		1 10	nA
	ICOM(off)		Room Full	- 1 - 10		1 10	
Channel-On Leakage Current	ICOM(on)	V+ = 3.3 V, VNO, VNC = VCOM = 0.3 V/3 V	Room Full	- 1 - 10		1 10	
Digital Control							
Input High Voltage	VINH		Full	1.4			V
Input Low Voltage	VINL		Full			0.5	
Input Capacitance ^d	Cin		Full		5.5		pF
Input Current ^f	IINL or IINH	VIN = 0 or V+	Full	- 1		1	μA
Dynamic Characteristics							
Turn-On Time	tON	VNO or VNC = 1.5 V, RL = 50 Ω, CL = 35 pF V+ = 2.7 V, figures 1 and 2	Room Full		20	30 35	ns
Turn-Off Time	tOFF		Room Full		18	28 33	
Break-Before-Make Time	td		Room	1			
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω, figure 3	Room		5.8		pC
Off-Isolation ^d	OIRR	RL = 1 kΩ, CL = 5 pF, f = 1 MHz	Room		- 56		dB
Crosstalk ^d	XTALK		Room		- 89		
NO, NC Off Capacitance ^d	CNO(off) CNC(off)	V+ = 3.6 V, VIN = 0 or V+, f = 1 MHz	Room		81		pF
Channel-On Capacitance ^d	CON		Room		103		
Power Supply							
Power Supply Range	V+			1.5		3.6	V
Power Supply Current	I+	V+ = 3.6 V, VIN = 0 or V+			0.01	1.0	μA

Notes:

a. Room = 25 °C, Full = as determined by the operating suffix.

b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.

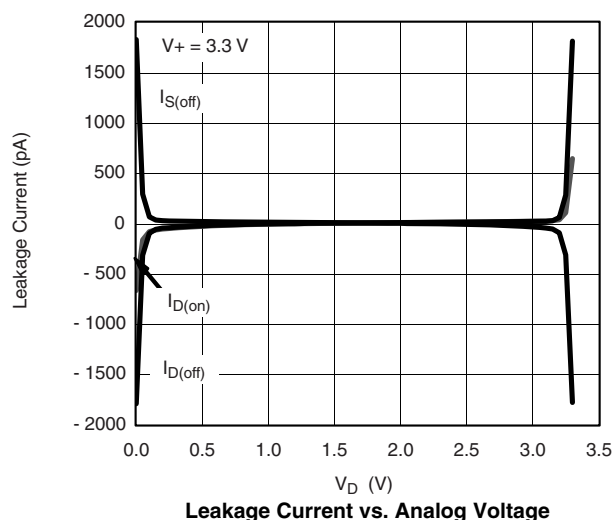
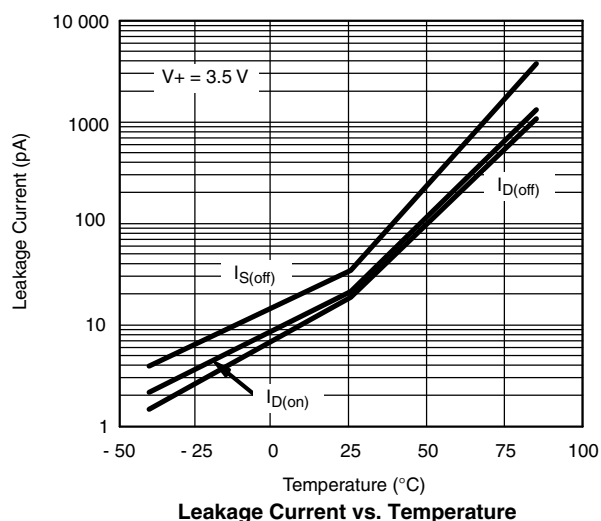
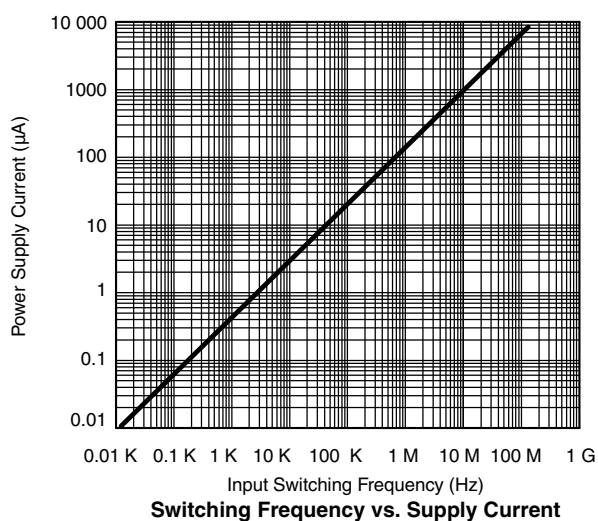
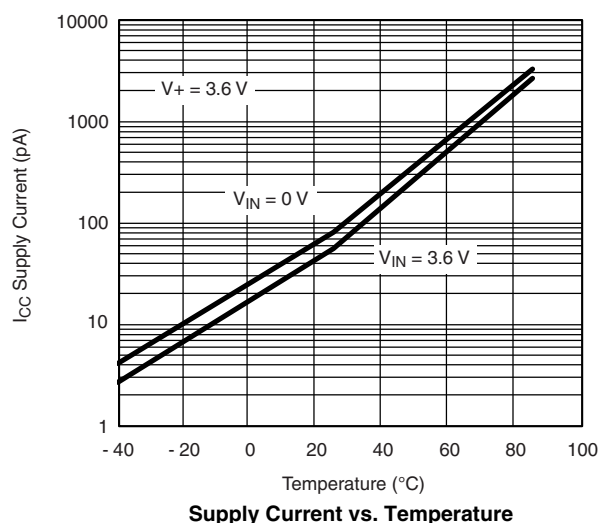
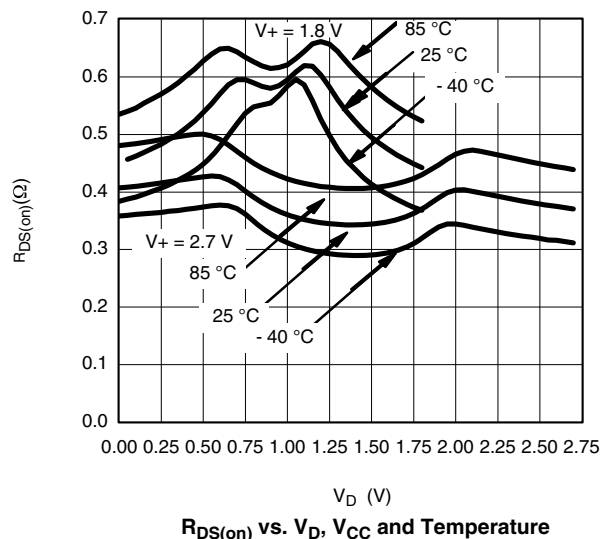
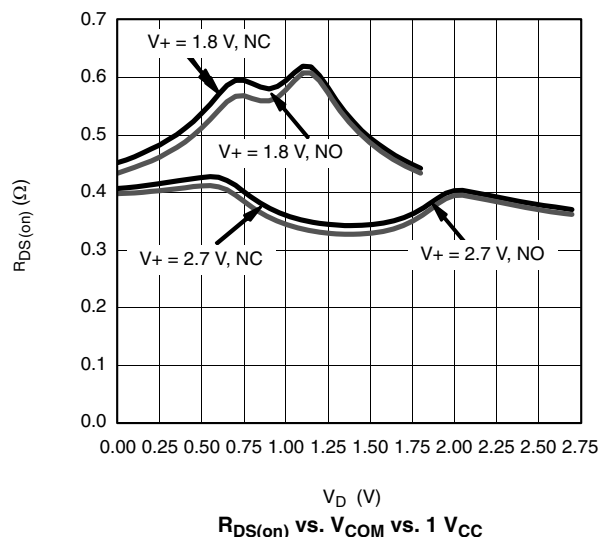
c. Typical values are for design aid only, not guaranteed nor subject to production testing.

d. Guarantee by design, nor subjected to production test.

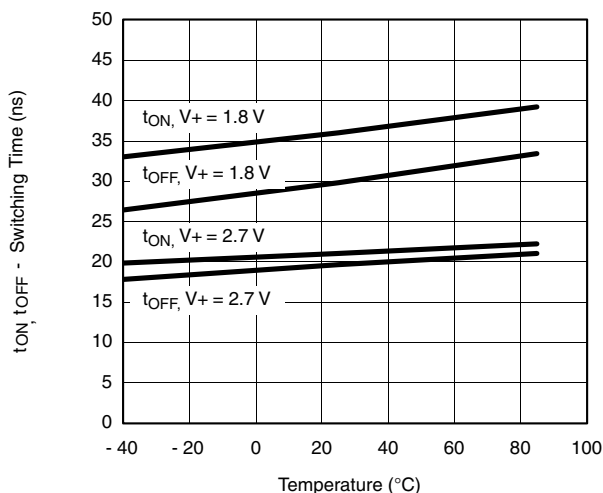
e. V_{IN} = input voltage to perform proper function.

f. Guaranteed by 3 V leakage testing, not production tested.

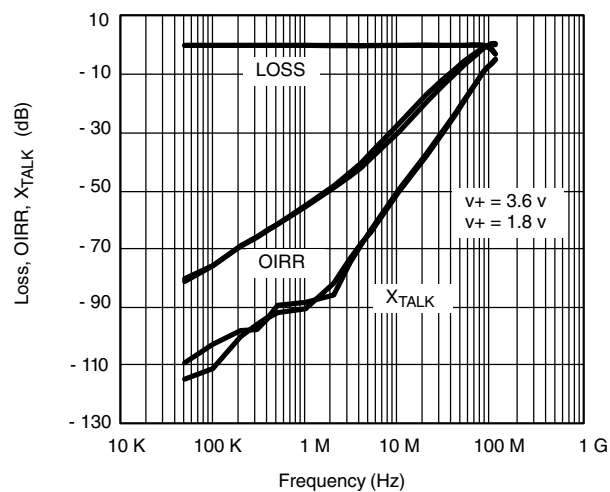
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


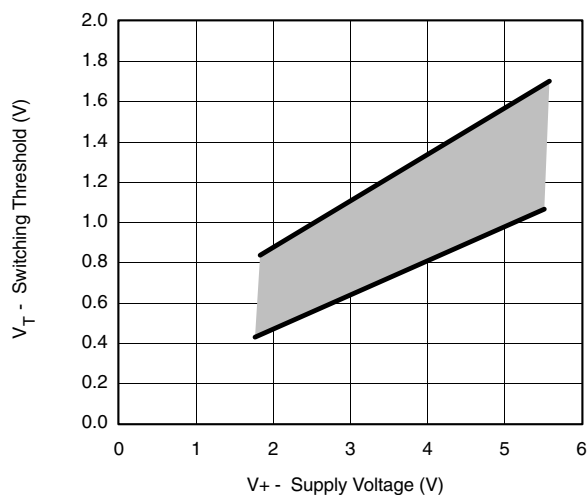
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



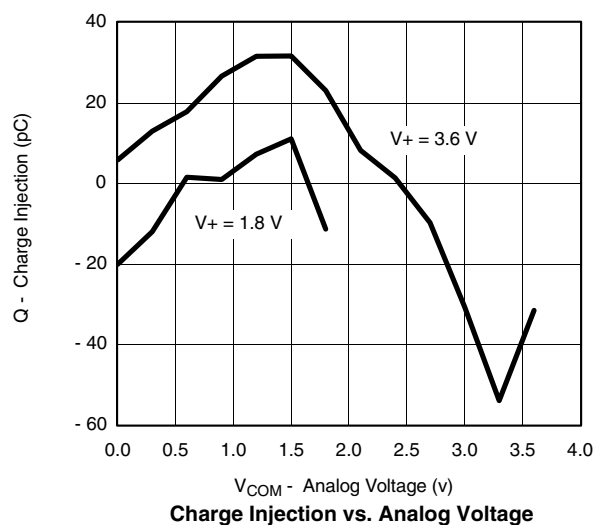
Switching Time vs. V_{CC} and Temperature



Insertion Loss, Off-Isolation Crosstalk vs. Frequency

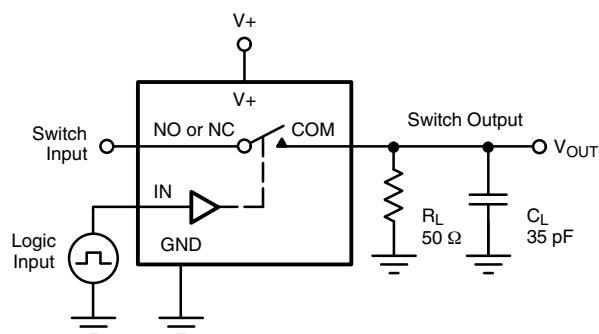


Switching Threshold vs. Supply Voltage



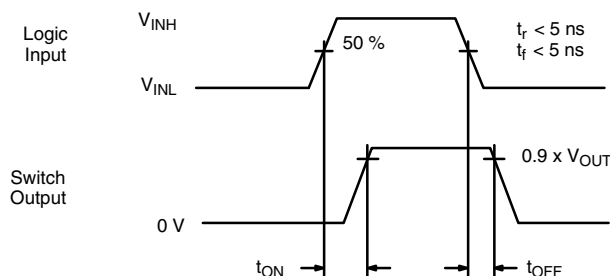
Charge Injection vs. Analog Voltage

TEST CIRCUITS



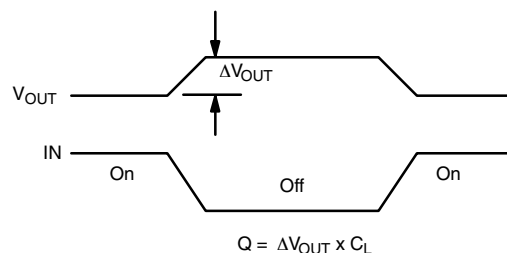
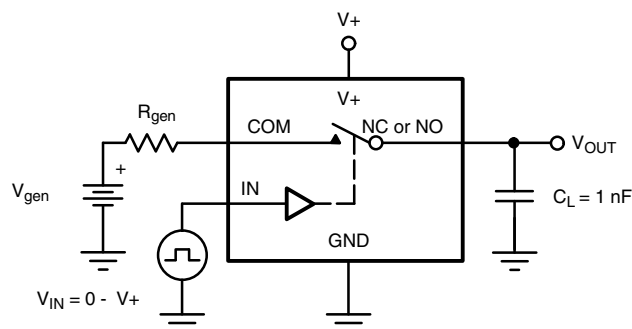
C_L (includes fixture and stray capacitance)

$$V_{OUT} = V_{COM} \left(\frac{R_L}{R_L + R_{ON}} \right)$$



Logic "1" = Switch On
Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 1. Switching Time



IN depends on switch configuration: input polarity determined by sense of switch.

Figure 2. Charge Injection

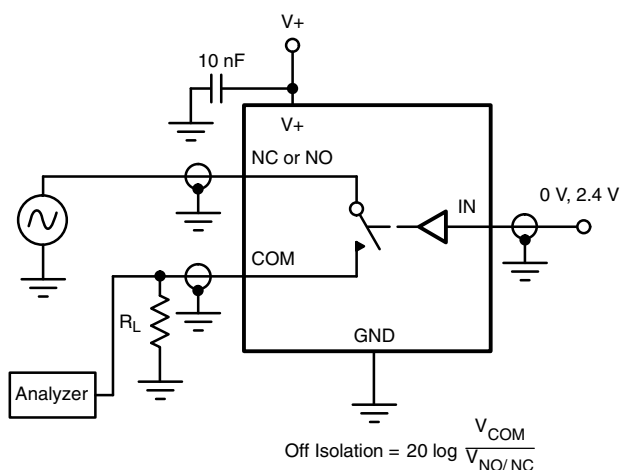


Figure 3. Off-Isolation

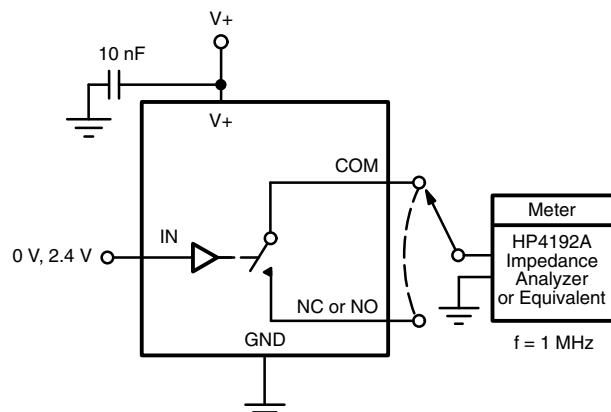


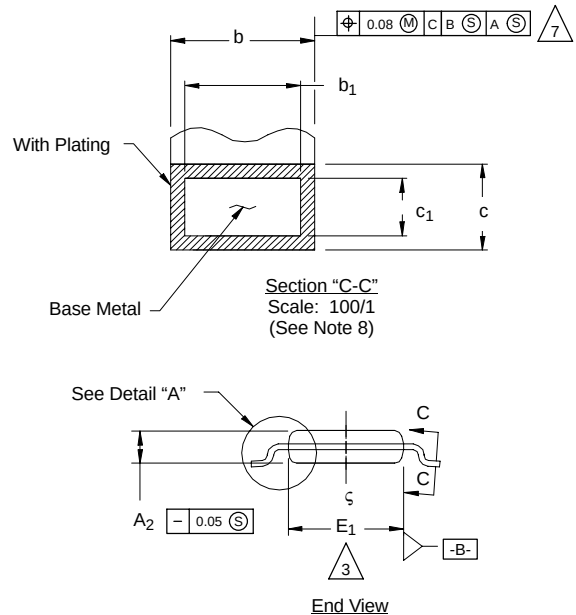
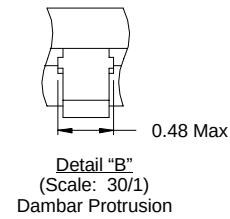
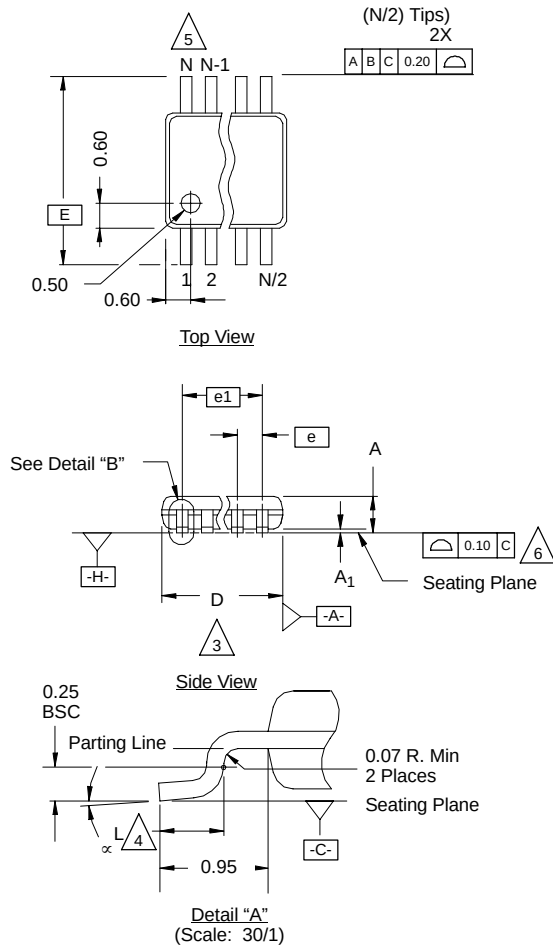
Figure 4. Channel Off/On Capacitance

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72708.



MSOP: 8-LEADS

JEDEC Part Number: MO-187, (Variation AA and BA)



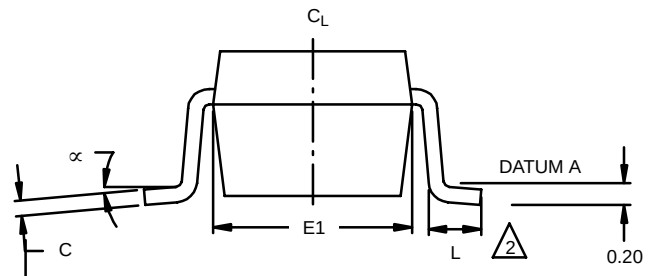
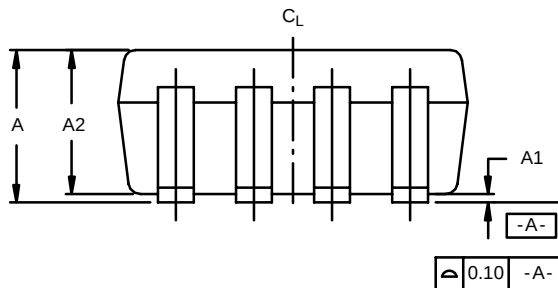
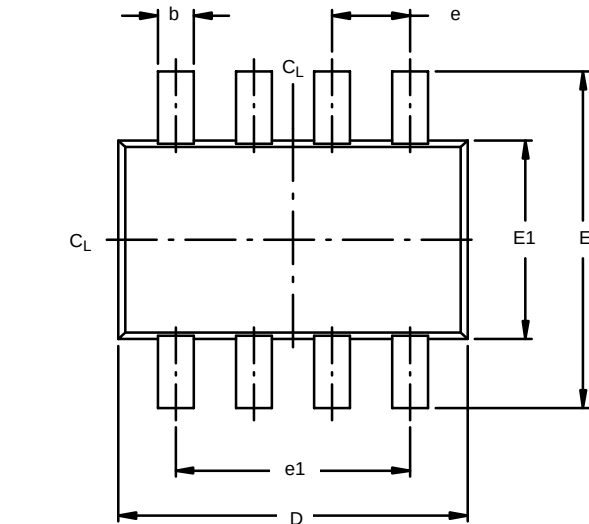
NOTES:

- Die thickness allowable is 0.203 ± 0.0127 .
- Dimensioning and tolerances per ANSI.Y14.5M-1994.
- Dimensions "D" and "E₁" do not include mold flash or protrusions, and are measured at Datum plane $\square\text{-H-}$, mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimension is the length of terminal for soldering to a substrate.
- Terminal positions are shown for reference only.
- Formed leads shall be planar with respect to one another within 0.10 mm at seating plane.
- The lead width dimension does not include Dambar protrusion. Allowable Dambar protrusion shall be 0.08 mm total in excess of the lead width dimension at maximum material condition. Dambar cannot be located on the lower radius or the lead foot. Minimum space between protrusions and an adjacent lead to be 0.14 mm. See detail "B" and Section "C-C".
- Section "C-C" to be determined at 0.10 mm to 0.25 mm from the lead tip.
- Controlling dimension: millimeters.
- This part is compliant with JEDEC registration MO-187, variation AA and BA.
- Datums $\square\text{-A-}$ and $\square\text{-B-}$ to be determined Datum plane $\square\text{-H-}$.
- Exposed pad area in bottom side is the same as the leadframe pad size.

N = 8L

Dim	MILLIMETERS			Note
	Min	Nom	Max	
A	-	-	1.10	
A₁	0.05	0.10	0.15	
A₂	0.75	0.85	0.95	
b	0.25	-	0.38	8
b₁	0.25	0.30	0.33	8
c	0.13	-	0.23	
c₁	0.13	0.15	0.18	
D	3.00 BSC			3
E	4.90 BSC			
E₁	2.90	3.00	3.10	3
e	0.65 BSC			
e₁	1.95 BSC			
L	0.40	0.55	0.70	4
N	8			5
α	0°	4°	6°	
ECN: T-02080—Rev. C, 15-Jul-02 DWG: 5867				

SOT-23 : 8-LEAD



NOTES:

1. All dimensions are in millimeters.
2. Foot length measured at intercept point between Datum A and lead surface.
3. Package outline exclusive of mold flash and metal burr.
4. Package outline inclusive of solder plating.
5. No molding flash allowed on the top and bottom lead surface.

Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.90	1.27	1.45	0.035	0.05	0.057
A1	0.00	0.0762	0.15	0.000	0.003	0.006
A2	0.90	1.20	1.30	0.035	0.047	0.051
b	0.22	0.30	0.38	0.009	0.012	0.015
C	0.09	0.152	0.20	0.004	0.006	0.008
D	2.80	2.9	3.00	0.11	0.114	0.118
E	2.60	2.8	23.00	0.102	0.11	0.118
E1	1.50	1.65	1.75	0.059	0.065	0.069
e	0.65 REF			0.026 REF		
e1	1.95 REF			0.077 REF		
L	0.35	0.45	0.55	0.014	0.018	0.022
α	0°	4°	8°	0°	4°	8°
ECN: C-03085—Rev. A, 07-Apr-03 DWG: 5895						



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.